

# SB1040L~SB10100L

### 10.0A Low VF Surface Mount **Schottky Barrier Rectifiers**

#### **Features**

- Ultra Low Forward Voltage Drop.
- Very low profile-typical height of 1.10mm
- Low Power Losses, High Efficiency Operation
- Low Thermal Resistance Package.
- High Operating Junction Temperature.

### Mechanical data

- Epoxy:UL94-V0 rated flame retardant
- Terminals:Solderable per MIL-STD-750,Method 2026

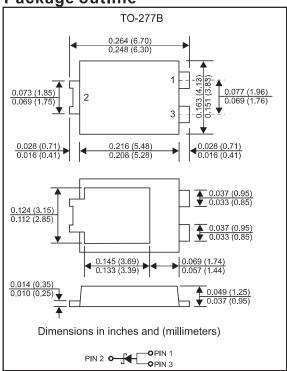








### Package outline



### **Maximum Ratings And Electrical Characteristics**

Parameter	SYMBOLS	SB1040L	SB1045L	SB1050L	SB1060L	SB1080L	SB10100L	UNITS
Maximum repetitive peak reverse voltage	VRRM	40	45	50	60	80	100	V
Maximum RMS voltage	VRMS	28	31.5	35	42	56	70	V
Maximum DC blocking voltage	VDC	40	45	50	60	80	100	V
Maximum average forward rectified current at TL=100°C	I <sub>(AV)</sub>	10.0					А	
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	İfsm	175.0					А	
Maximum instantaneous forward voltage at 2.0A at 10.0A	VF	0.35       0.40       0.45         0.48       0.55       0.70				V		
Maximum DC reverse current T A =25°C at rated DC blocking voltage TA=125°C	İR	0.5 50 0.2 20				mA		
Typical thermal resistance	RqJA	60.0					°C/W	
Operating junction temperature range	TJ	-55 to +150					°C	
Storage temperature range	Тѕтс	-55 to +150				°C		

Ratings at 25℃ ambient temperature unless otherwise specified. Single phase half-wave 60Hz,resistive or inductive load, for capacitive load current derate by 20%.

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### Rating and characteristic curves

FIG. 1- DERATING CURVE OUTPUT RECTIFIED CURRENT

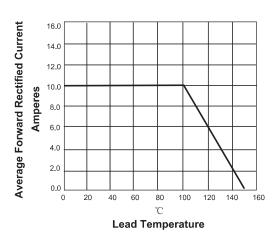
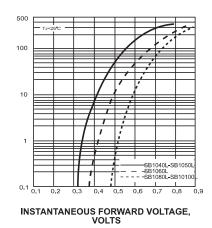


FIG. 3-TYPICAL FORWARD VOLTAGE CHARACTERISTICS



INSTANTANEOUS FORWARD CURRENT, AMPERES

FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT PERLEG

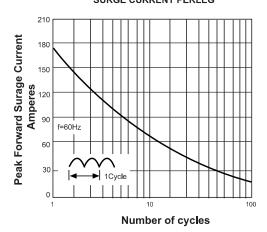
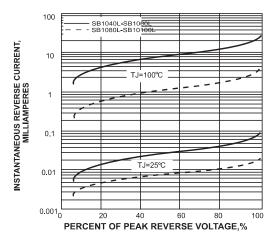


FIG. 4-TYPICAL REVERSE LEAKAGE CHARACTERISTICS

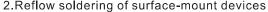


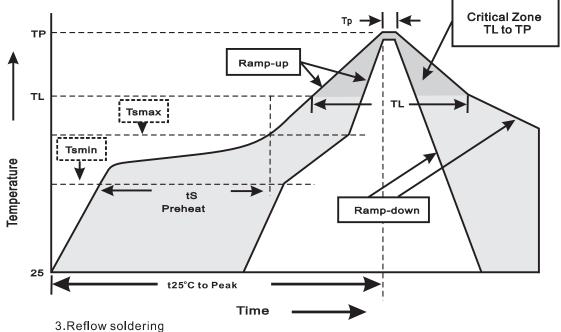
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### 10.0A Low VF Surface Mount **Schottky Barrier Rectifiers**

### Suggested thermal profiles for soldering processes

1.Storage environment: Temperature=5°C~40°C Humidity=55% $\pm$ 25% 2.Reflow soldering of surface-mount devices





Profile Feature	Soldering Condition				
Average ramp-up rate(T∟ to T♭)	<3°C/sec				
Preheat -Temperature Min(Tsmin) -Temperature Max(Tsmax) -Time(min to max)(ts)	150°C 200°C 60~120sec				
Tsmax to T∟ -Ramp-upRate	<3°C/sec				
Time maintained above: -Temperature(TL) -Time(tL)	217°C 60~260sec				
Peak Temperature(T <sub>P</sub> )	255°C-0/+5°C				
Time within 5°C of actual Peak Temperature(t <sub>P</sub> )	10~30sec				
Ramp-down Rate	<6°C/sec				
Time 25°C to Peak Temperature	<6minutes				

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